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Patent / Docket No. 24061.37 (TSMC2002-130) Customer No. 4271'

INITED STATES PATENT AND TRADEMARK OFFICE

Docket No.: 24061.37 Chung Long Chang, et al. Applicant: (TSMC2002-1305) 10/686,866 Serial No.: Examiner: To Be Determined Filed: October 16, 2003 Art Unit: 2831 For: Compact Capacitor Structure

Having High Unit Capacitance

PETITION AND RESPONSE TO NOTICE TO FILE CORRECTED APPLICATION PAPERS FILING DATE GRANTED

Mail Stop Missing Parts Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Notice to File Corrected Application Papers (Filing Date Granted) mailed on April 29, 2004 requiring submission of omitted items, which includes the abstract and page 14, for the above-referenced application, Applicants hereby petition that the omitted items were in fact deposited in the U.S. Patent and Trademark Office with the nonprovisional application papers at the time of filing.

Applicants enclose herewith a copy of the abstract and page 14 of the specification (description and claims). Also, Applicants enclose a copy of the Express Mail Certificate, Utility Patent Application Transmittal and return receipt postcard indicating that the U.S. Patent and Trademark Office received 18 pages of the specification, which included page 14 and the abstract.

Enclosed is the petition fee of \$130.00 as set forth under 37 CFR 1.17(h). However, Applicants submit that the enclosures provide sufficient evidence that the above items were not, in fact, omitted and therefore, Applicant respectfully requests refund of the petition fee of \$130.00.

The Commissioner is hereby authorized to charge any deficiency fees or credit refunds or any overpayments associated with this communication to Deposit Account No. 08-1394.

6-1-04

HAYNES AND BOONE, LLP 901 Main Street, Suite 3100 Dallas, Texas 75202-3789 Telephone: 972-739-8635

Facsimile: 214-200-0853

Respectfully-submitted,

David M. O'Dell Reg. No. 42,044

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to the Mail Stop: Missing Parts, Commissioner for Patents P.O. Box 1450; Alexandria, VA 1450 on the date indicated below.

06/04/2004 SSESHE1 00000078 10686866

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United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspio.gov

APPLICATION NUMBER

FILING OR 371 (c) DATE

FIRST NAMED APPLICANT

ATTORNEY DOCKET NUMBER

10/686,866

10/16/2003

Chung Long Chang

24061. / TSMC2002-1305

27683 HAYNES AND BOONE, LLP 901 MAIN STREET, SUITE 3100 DALLAS, TX 75202



CONFIRMATION NO. 7401
FORMALITIES LETTER
OC000000012479913

Date Mailed: 04/29/2004

NOTICE TO FILE CORRECTED APPLICATION PAPERS

Filing Date Granted

An application number and filing date have been accorded to this application. The application is informal since it does not comply with the regulations for the reason(s) indicated below. Applicant is given TWO MONTHS from the date of this Notice within which to correct the informalities indicated below. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

The required item(s) identified below must be timely submitted to avoid abandonment:

• An abstract of the technical disclosure not exceeding 150 words in length and commencing on a separate sheet in compliance with 37 CFR 1.72(b) is required. An abstract was not provided for this application.

The following item(s) appear to have been **omitted** from the application:

- Page(s) 14 of the specification (description and claims).
- I. Should applicant contend that the above-noted omitted item(s) was in fact deposited in the U.S. Patent and Trademark Office (USPTO) with the nonprovisional application papers, a copy of this Notice and a petition (and \$130.00 petition fee (37 CFR 1.17(h))) with evidence of such deposit **must** be filed within **TWO MONTHS** of the date of this Notice. The petition fee will be refunded if is determined that the item(s) was received by the USPTO.
- II. Should applicant desire to supply the omitted item(s) and accept the date that such omitted item(s) was filed in the USPTO as the filing date of the above-identified application, a copy of this Notice, the omitted item(s) (with a supplemental oath or declaration in compliance with 37 CFR 1.63 and 1.64 referring to such items), and a petition under 37 CFR 1.182 (with the \$130.00 petition fee (37 CFR 1.17(h)) requesting the later filing date **must** be filed within **TWO MONTHS** of the date of this Notice.

Applicant is advised that generally the filing fee required for an application is the filing fee in effect on the filing date accorded the application and that payment of the requisite basic filing fee on a date later than the filing date of the application requires payment of a surcharge (37 CFR 1.16(e)). To avoid processing delays and payment of a surcharge, applicant should submit any balance due for the requisite filing fee based on the later filing date being requested when submitting the omitted items(s) and the petition (and petition fee) requesting the later filing date

III. The failure to file a petition (and petition fee) under the above options (I) or (II) within **TWO MONTHS** of the date of this Notice (37 CFR 1.181(f)) will be treated as a constructive acceptance by the applicant of the

application as deposited in the USPTO. THIS <u>TWO MONTH</u> PERIOD IS NOT EXTENDABLE UNDER 37 CFR 1.136(a) or (b). In the absence of a timely filed petition in reply to this Notice, the application will maintain a filing date as of the date of deposit of the application papers in the USPTO, and original application papers (*i.e.*, the original disclosure of the invention) will include only those application papers present in the USPTO on the date of deposit.

In the event that applicant elects not to take action pursuant to options (I) or (II) above (thereby constructively electing option (III)), amendment of the specification to renumber the pages consecutively and cancel incomplete sentences caused by any omitted page(s), and/or amendment of the specification to cancel all references to any omitted drawing(s), relabel the drawing figures to be numbered consecutively (if necessary), and correct the references in the specification to the drawing figures to correspond with any relabeled drawing figures, is required. A copy of the drawing figures showing the proposed changes in red ink should accompany with any drawing changes. Such amendment and/or correction to the drawing figures, if necessary, should be by way of preliminary amendment submitted prior to the first Office action to avoid delays in the prosecution of the application.

Replies should be mailed to:

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Commissioner for Patents

P.O. Box 1450

Alexandria VA 22313-1450

A copy of this notice <u>MUST</u> be returned with the reply.

Customer Service Center

Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE



HE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Chang et al.

Serial No. Unknown

Filed: Herewith

For: Compact Capacitor Structure Having High

Unit Capacitance

Group Art Unit: Unknown

Examiner: Unknown

EXPRESS MAIL CERTIFICATE

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Express Mail Number: EV 333435900 US

Date of Deposit: October 16, 2003

I hereby certify that the following attached papers and fee:

- 1. Utility Patent Application Transmittal;
- 2. Fee Transmittal (in duplicate);
- 3. Application Data Sheet;
- 4. Patent Application consisting of 18 pages of specification, 25 claims and 1 page Abstract of Disclosure;
- 5. Four (4) drawing sheets;
- 6. Executed Declaration;
- 7. Assignment and Recordation Cover Sheet;
- Check in the amount of \$900.00 (\$860.00 for filing fee and \$40.00 for recordation of Assignment);
 and
- 9. Return Postcard

are being deposited with United States Postal Service "Express Mail Post Office to Addressee" to the Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Bonnie Boyle

Typed or Printed Name

Signature

R-57709_1.DOC

Approved for use through 07/31/2006. OMB 0651-0032 U.S. Patent and Trademark Office. U.S. DEPARTMENT OF COMMERCE of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

UTILITY PATENT APPLICATION **TRANSMITTAL**

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Attorney Docket No.	24061.37 / TSMC2002-1305
First Inventor	Chung Long Chang
Title	Compact Capacitor Structure Having High Unit Capacitance
Express Mail Lahel No.	EV 333435900 US

See MPEP	APPLICATION ELEMENTS chapter 600 concerning utility patent application contents.	ADDRESS TO: Commission P.O. Box 145	itent Application ler for Patents 50 /A 22313-1450			
(Subm. 2. Applic See 3 3. Specil (prefer Desc - Cross - State - Refer or a c - Back - Brief - Brief - Detai - Claim		7. CD-ROM or CD-R in duplicated Computer Program (Appendix 8. Nucleotide and/or Amino Acid Set (if applicable, all necessary) a. Computer Readable For b. Specification Sequence i. CD-ROM or CD- ii. Paper c. Statements verifying in	equence Submission orm (CRF) ce Listing on: -R (2 copies); or			
Abstract of the Disclosure 4. Drawing(s) (35 U.S.C. 113). [Total Sheets						
specification following the title, or in an Application Data Sheet under 37 CFR 1.76: Continuation Divisional Continuation-in-part (CIP) of prior application No.: Prior application information: Examiner For CONTINUATION OF DIVISIONAL APPS only; The entire disclosure of the prior application, from which an oath or declaration is supplied under Box 5b, is considered a part of the disclosure of the accompanying continuation or divisional application and is hereby incorporated by reference. The incorporation can only be relied upon when a portion has been inadvertently omitted from the submitted application parts.						
, , ,		DENCE ADDRESS				
☑ Custon	ner Number: 27683	OR Corresp	oondence address below			
Name	David M. O'Dell					
Address	Haynes and Boone, LLP					
City	901 Main Street, Suite 3100	State T-v	Zip Code 75202			
Country	Dallas USA T	elephone 9720739-8635	75202 Fax 972-692-9118			
			372-032-3110			
Name (Print/Ty	(pe) David M. OrDell	Registration No. (Attorney/Agent) 42	Date (2) (/ 2)			
Signature	1 K V · / / K Vel X		Date 10-16-03			

This collection of information is required by 37 CFR 1.53(b). The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 12 minutes to complete including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

If you need assistance in completing the form, call 1-800-PTO-9199 and select option 2.

DESCRIPTION OF PAPER			` ' '		on Data Sheet; Utility
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U.S. Patent	Office on the date stam	ped hereon.			22581 118 070
			•		10/686866
APPLICANT	Chang et al.				101603
SERIAL NO.	Unknown		DATE FILED	Herewith	CERTAVI
ATTORNEY DOCKET NO.	24061.37				Car and
TITLE	Compact Capacito	r Structure Having Hig	gh Unit Capacitance		PANADOR & POONE
•				·	
SENDER'S	DMO/bb		DATE	10-16-0	. 3



- The capacitor device recited in Claim 1 wherein the second and third electrodes each include a plurality of conductive layers.
- 12. The capacitor device recited in Claim 1 wherein a total unit capacitance of the capacitor device ranges between about 1.3 fF/ μ m² and about 2.0 fF/ μ m².
- 13. The capacitor device recited in Claim 1 wherein a total unit capacitance of the capacitor device is about 1.5 fF/μm².
- 14. A method of manufacturing a capacitor device, comprising:

 forming a first interconnect over and coupled to a first electrode;

 coupling the first interconnect to a second electrode formed over the first electrode; and

 forming a second interconnect over and coupled to a third electrode, the third electrode

 interposing the first and second electrodes.
- 15. The method recited in Claim 14 further comprising:

 forming a first insulating layer interposing the first and third electrodes;

 forming a second insulating layer interposing the second and third electrodes; and

 forming a third insulating layer interposing the second electrode and the first and second
 interconnects.

COMPACT CAPACITOR STRUCTURE HAVING HIGH UNIT CAPACITANCE

ABSTRACT

[0031] The present disclosure provides a capacitor device including a first electrode formed over a substrate and a first insulating layer formed over the first electrode. A second electrode is formed over the first insulating layer and a second insulating layer is formed over the second electrode. A third electrode is formed over the second insulating layer and a third insulating layer is formed over the third electrode. First, second and third vias are then formed. The first via couples the first electrode and a first interconnect, the second via couples the second electrode and a second interconnect and the third via couples the third electrode and the first interconnect.